



## Surface Mount 500 mW Zener Diodes

*Screening in reference to MIL-PRF-19500 available*



**DO-213AA Package**

**Important:** For the latest information, visit our website <http://www.microsemi.com>.

### FEATURES

- Surface mount equivalents to JEDEC registered 1N5985 to 1N6031 series.
- Similar to operating current conditions of the BZX55 Pro Electron series of Zener products in Europe.
- Multiple voltage tolerances are available (see [part nomenclature](#)).
- Internal metallurgical bonds.
- High-reliability screened equivalents in reference to MIL-PRF-19500 are available.
- RoHS compliant versions available (commercial grade only).

Also available in:

 **DO-35 (DO204AH)**  
(axial-leaded)  
[1N5985B-1 – 1N6031B-1](#)

### APPLICATIONS / BENEFITS

- Regulates voltage over a broad operating current and temperature range.
- Extensive selection from 2.4 to 200 volts.
- Non-sensitive to ESD (MIL-STD-750, method 1020).
- Minimal capacitance (see [Figure 2](#)).
- Inherently radiation hard as described in Microsemi “[MicroNote 050](#)”.

### MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit
Power Dissipation at 25°C <sup>(1)</sup> (Also see derating in <a href="#">Figure 1</a> )	P <sub>D</sub>	0.5	Watts
Junction and Storage Temperature	T <sub>J</sub> and T <sub>STG</sub>	-65 to +175	°C
Thermal Resistance Junction-to-End Cap <sup>(2)</sup>	R <sub>EJL</sub>	150	°C/W
Thermal Resistance Junction-to-Ambient <sup>(2)</sup>	R <sub>EJA</sub>	300	°C/W
Forward Voltage @ 200mA	V <sub>F</sub>	1.1	Volts
Solder Temperature @ 10 s	T <sub>SP</sub>	260	°C

- Notes:**
1. At end cap temperatures T<sub>EC</sub> ≤ 100 °C or 0.5 watts at ambient T<sub>A</sub> ≤ 25 °C when mounted on FR4 PC board as described for thermal resistance.
  2. When mounted on FR4 PC board (1 oz Cu) with recommended footprint (see [last page](#)).

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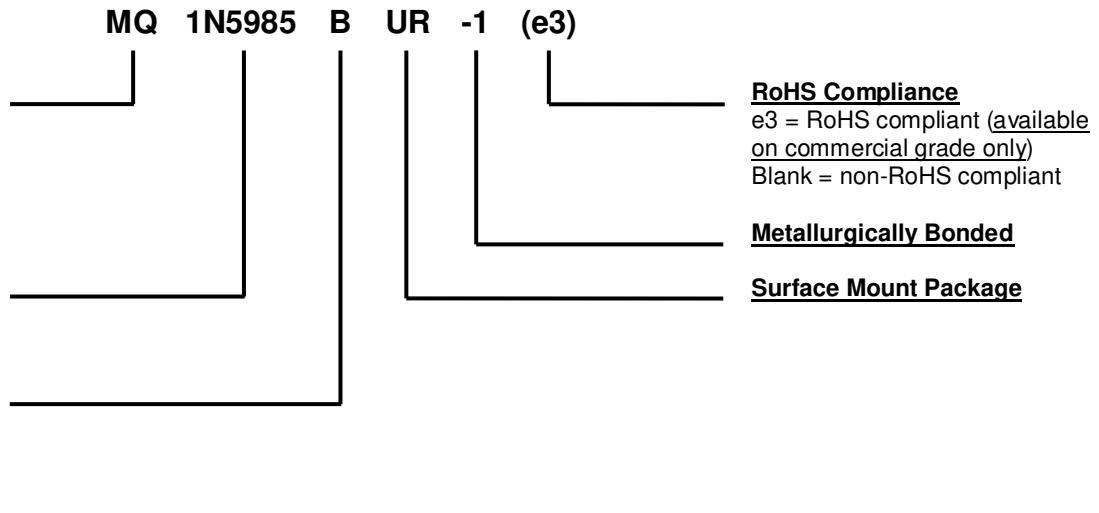
#### **Website:**

[www.microsemi.com](http://www.microsemi.com)

### MECHANICAL and PACKAGING

- CASE: Hermetically sealed glass DO-213AA (SOD80 or MLL34) MELF style package.
- TERMINALS: End caps tin-lead or RoHS compliant matte-tin (commercial grade only) plating solderable per MIL-STD-750, method 2026.
- POLARITY: Cathode indicated by band where diode is to be operated with the banded end positive with respect to the opposite end for Zener regulation.
- MARKING: Cathode band only.
- TAPE & REEL option: Standard per EIA-481-B with 12 mm tape (add "TR" suffix to part number). Consult factory for quantities.
- WEIGHT: 0.04 grams.
- See [Package Dimensions](#) on last page.

### PART NOMENCLATURE



### SYMBOLS & DEFINITIONS

Symbol	Definition
$I_R$	Reverse Current: The maximum reverse (leakage) current that will flow at the specified voltage and temperature.
$I_z$ , $I_{zT}$ , $I_{zK}$	Regulator Current: The dc regulator current ( $I_z$ ), at a specified test point ( $I_{zT}$ ), near breakdown knee ( $I_{zK}$ ).
$I_{zM}$	Maximum Regulator (Zener) Current: The maximum rated dc current for the specified power rating.
$V_F$	Maximum Forward Voltage: The maximum forward voltage the device will exhibit at a specified current.
$V_z$	Zener Voltage: The Zener voltage the device will exhibit at a specified current ( $I_z$ ) in its breakdown region.
$Z_{zT}$ or $Z_{zK}$	Dynamic Impedance: The small signal impedance of the diode when biased to operate in its breakdown region at a specified rms current modulation (typically 10% of $I_{zT}$ or $I_{zK}$ ) and superimposed on $I_{zT}$ or $I_{zK}$ respectively.

**ELECTRICAL CHARACTERISTICS @ 30°C Lead Temperature. Lead Length 3/8".**

JEDEC Type Number	Nominal Zener Voltage $V_z$ @ $I_{zT}$ (Note 2)	Test Current $I_{zT}$	Max. Zener Impedance (Note 1)				Max. Reverse Leakage Current				Max. dc Zener Current $I_{zM}$ (Note 3)	Typical Temp. Coeff. of Zener Voltage $\alpha_{VZ}$ %/°C		
			$Z_{zT}$ @ $I_{zT}$		$Z_{zK}$ @ $I_{zK} = 0.25$ mA		$I_R$		@ $V_R$					
			Ohms		Ohms		μA		Volts					
			B,C,D Suffix	A Suffix	B,C,D Suffix	A Suffix	B,C,D Suffix	A Suffix	B,C,D Suffix	A Suffix				
1N5985BUR	2.4	5.0	100	110	1800	2000	100	100	1.0	0.5	208	-0.090		
1N5986BUR	2.7	5.0	100	110	1900	2200	75	100	1.0	0.5	185	-0.075		
1N5987BUR	3.0	5.0	95	100	2000	2300	50	100	1.0	0.5	167	-0.070		
1N5988BUR	3.3	5.0	95	100	2200	2400	25	75	1.0	0.5	152	-0.060		
1N5989BUR	3.6	5.0	90	95	2300	2500	15	50	1.0	0.5	139	-0.055		
1N5990BUR	3.9	5.0	90	95	2400	2500	10	25	1.0	1.0	128	-0.045		
1N5991BUR	4.3	5.0	88	90	2500	2500	5.0	15	1.0	1.0	116	-0.010		
1N5992BUR	4.7	5.0	70	90	2200	2500	3.0	10	1.5	1.0	106	+0.010		
1N5993BUR	5.1	5.0	50	88	2050	2500	2.0	5.0	2.0	1.0	98	+0.025		
1N5994BUR	5.6	5.0	25	70	1800	2200	2.0	3.0	3.0	1.5	89	+0.035		
1N5995BUR	6.2	5.0	10	50	1300	2050	1.0	2.0	4.0	2.0	81	+0.040		
1N5996BUR	6.8	5.0	8.0	25	750	1800	1.0	2.0	5.2	3.0	74	+0.044		
1N5997BUR	7.5	5.0	7.0	10	600	1300	0.5	1.0	6.0	4.0	67	+0.051		
1N5998BUR	8.2	5.0	7.0	15	600	750	0.5	1.0	6.5	5.2	61	+0.055		
1N5999BUR	9.1	5.0	10	18	600	600	0.1	0.5	7.0	6.0	55	+0.061		
1N6000BUR	10	5.0	15	22	600	600	0.1	0.5	8.0	6.5	50	+0.065		
1N6001BUR	11	5.0	18	25	600	600	0.1	0.1	8.4	7.0	45	+0.068		
1N6002BUR	12	5.0	22	32	600	600	0.1	0.1	9.1	8.0	42	+0.073		
1N6003BUR	13	5.0	25	36	600	600	0.1	0.1	9.9	8.4	38	+0.075		
1N6004BUR	15	5.0	32	42	600	600	0.1	0.1	11	9.1	33	+0.079		
1N6005BUR	16	5.0	36	48	600	600	0.1	0.1	12	9.9	31	+0.080		
1N6006BUR	18	5.0	42	55	600	600	0.1	0.1	14	11	28	+0.083		
1N6007BUR	20	5.0	48	62	600	600	0.1	0.1	15	12	25	+0.085		
1N6008BUR	22	5.0	55	70	600	600	0.1	0.1	17	14	23	+0.087		
1N6009BUR	24	5.0	62	78	600	600	0.1	0.1	18	15	21	+0.090		
1N6010BUR	27	5.0	70	88	600	700	0.1	0.1	21	17	19	+0.091		
1N6011BUR	30	5.0	78	95	600	700	0.1	0.1	23	18	17	+0.093		
1N6012BUR	33	5.0	88	110	700	800	0.1	0.1	25	21	15	+0.094		
1N6013BUR	36	5.0	95	130	700	900	0.1	0.1	27	23	14	+0.094		
1N6014BUR	39	2.0	130	170	800	1000	0.1	0.1	30	25	13	+0.095		
1N6015BUR	43	2.0	150	180	900	1100	0.1	0.1	33	27	12	+0.095		
1N6016BUR	47	2.0	170	200	1000	1300	0.1	0.1	36	30	11	+0.096		
1N6017BUR	51	2.0	180	225	1300	1400	0.1	0.1	39	33	9.8	+0.096		
1N6018BUR	56	2.0	200	240	1400	1600	0.1	0.1	43	36	8.9	+0.096		
1N6019BUR	62	2.0	225	265	1400	1700	0.1	0.1	47	39	8.0	+0.097		
1N6020BUR	68	2.0	240	280	1600	2000	0.1	0.1	52	43	7.4	+0.097		
1N6021BUR	75	2.0	265	300	1700	2300	0.1	0.1	56	47	6.7	+0.098		
1N6022BUR	82	2.0	280	350	2000	2600	0.1	0.1	62	52	6.1	+0.098		
1N6023BUR	91	2.0	300	400	2300	3000	0.1	0.1	69	56	5.5	+0.099		
1N6024BUR	100	1.0	500	800	2600	4000	0.1	0.1	76	62	5.0	+0.110		
1N6025BUR	110	1.0	650	950	3000	4500	0.1	0.1	84	69	4.5	+0.110		
1N6026BUR	120	1.0	800	1250	4000	5000	0.1	0.1	91	76	4.2	+0.110		
1N6027BUR	130	1.0	950	1400	4500	5500	0.1	0.1	99	84	3.8	+0.110		
1N6028BUR	150	1.0	1250	1700	5000	6000	0.1	0.1	114	91	3.3	+0.110		
1N6029BUR	160	1.0	1400	2000	5500	7000	0.1	0.1	122	99	3.1	+0.110		
1N6030BUR	180	1.0	1700	2350	6000	8000	0.1	0.1	137	114	2.8	+0.110		
1N6031BUR	200	1.0	2000	2700	7000	9000	0.1	0.1	152	122	2.5	+0.110		

\* Indicates JEDEC registered data.

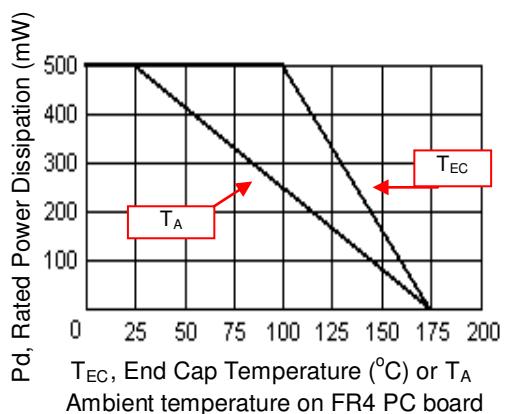
\*\* These may also be ordered as MLL5985B thru MLL6031B for the applicable part number and tolerance in this series.

**NOTES:**

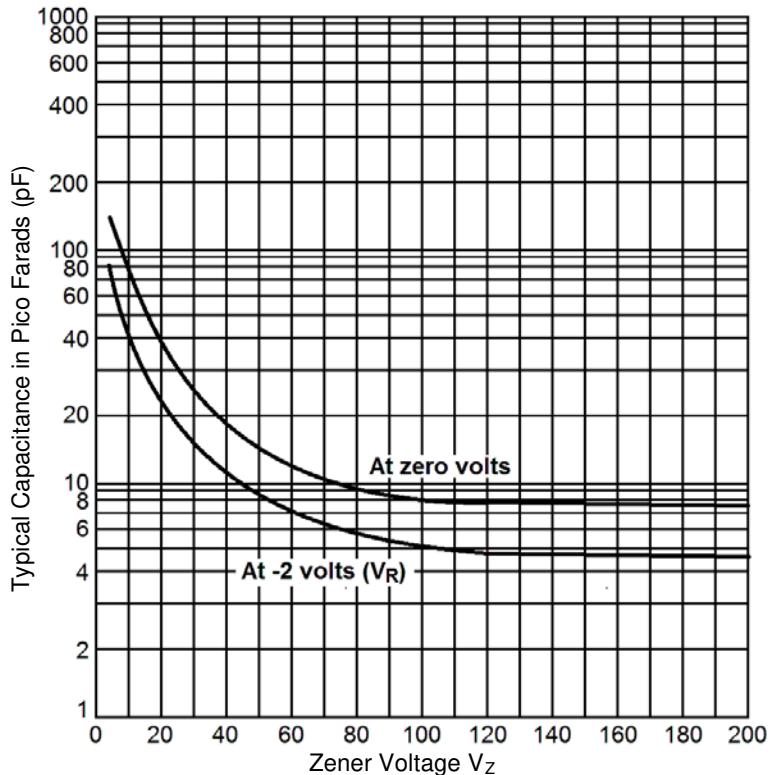
1. Zener impedance is derived from the 1 kHz ac voltage that results when an ac current having an rms value equal to 10% of dc Zener current ( $I_{ZT}$  or  $I_{ZK}$ ) is superimposed on  $I_{ZT}$  or  $I_{ZK}$ . See "[MicroNote 202](#)" for dynamic impedance variation with other operating currents.
2. Voltage measurements to be performed 20 seconds after application of the dc test current.
3. The maximum Zener current  $I_{ZM}$  shown is for the nominal voltages. The following formula can be used to determine the worst case current for any tolerance device:

$$I_{ZM} = \frac{P}{V_{ZM}}$$

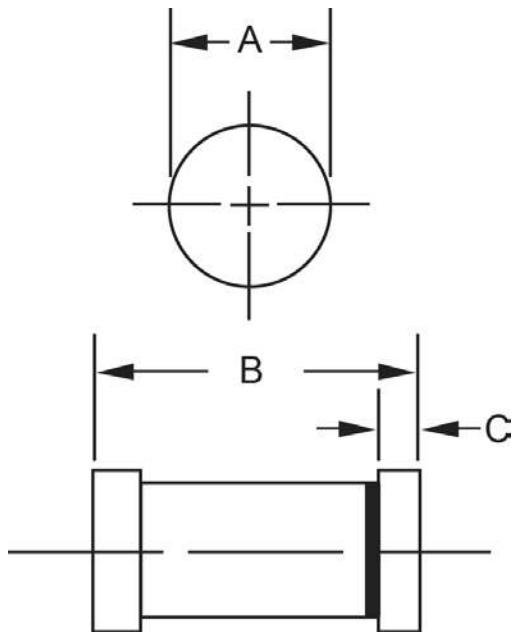
Where  $V_{ZM}$  is the high end of the voltage tolerance specified and P is the rated power of the device.

**GRAPHS**


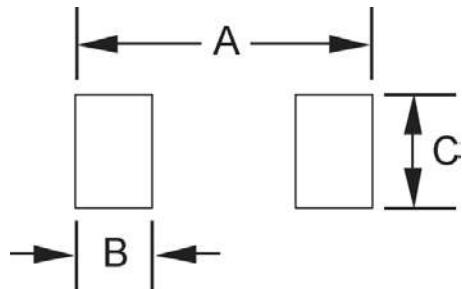
**FIGURE 1**  
POWER DERATING CURVE



**FIGURE 2**  
CAPACITANCE vs. ZENER VOLTAGE (TYPICAL)

**PACKAGE DIMENSIONS**


DIM	INCH		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.063	0.067	1.60	1.70
B	0.130	0.146	3.30	3.70
C	0.016	0.022	0.41	0.55

**PAD LAYOUT**


	INCH	mm
A	.200	5.08
B	.055	1.40
C	.080	2.03